19-3954; Rev 0; 1/06

MAXIM

21-Bit Deserializers with Programmable Spread Spectrum and DC Balance

General Description

The MAX9242/MAX9244/MAX9246 deserialize three LVDS serial-data inputs into 21 single-ended LVCMOS/LVTTL outputs. A separate parallel-rate LVDS clock provides the timing for deserialization. The MAX9242/MAX9244/MAX9246 feature spread-spectrum capability, allowing the output data and clock frequency to spread over a specified range to reduce EMI. The single-ended data and clock outputs are programmable for a frequency spread of ±2%, ±4%, or no spread. The spread-spectrum function is also available when the MAX9242/MAX9244/MAX9246 operate in non-DC-balanced mode. The modulation rate of the spread is 32kHz for a 33MHz LVDS clock input and scales linearly with frequency. The single-ended outputs have a separate supply, allowing +1.8V to +5V output logic levels.

The MAX9242/MAX9244/MAX9246 feature programmable DC balance, allowing isolation between a serializer and deserializer using AC-coupling. The MAX9242/MAX9244/MAX9246 operate with the MAX9209/MAX9213 serializers and are available with a rising-edge strobe (MAX9242) or falling-edge strobe (MAX9244/MAX9246). The LVDS inputs meet ISO 10605 ESD specifications with ±30kV Air-Gap Discharge and ±6kV Contact Discharge ratings.

The MAX9242/MAX9244/MAX9246 are available in a 48-pin TSSOP package and operate over the -40°C to +85°C temperature range.

Applications

Automotive Navigation Systems

Automotive DVD Entertainment Systems

Digital Copiers

Laser Printers

Selector Guide

PART	STROBE EDGE	OVER-SAMPLING	FREQUENCY RANGE	
			NON-DC BALANCE (MHz)	DC BALANCE (MHz)
MAX9242	Rising	Yes	20 to 40	16 to 34
MAX9244	Falling	Yes	20 to 40	16 to 34
MAX9246	Falling	No	8 to 20	6 to 18

Features

- ♦ **Programmable ±4%, ±2%, or OFF Spread-Spectrum Output for Reduced EMI**
- ♦ **Programmable DC-Balanced or Non-DC-Balanced Modes**
- ♦ **DC Balance Allows AC-Coupling for Wider Input Common-Mode Voltage Range**
- ♦ **Spread Spectrum Operates in DC-Balanced or Non-DC-Balanced Mode**
- ♦ **π / 4 Deskew by Oversampling (MAX9242/MAX9244)**
- ♦ **16MHz-to-34MHz (DC-Balanced) and 20MHz-to-40MHz (Non-DC-Balanced) Operation (MAX9242/MAX9244)**
- ♦ **6MHz-to-18MHz (DC-Balanced) and 8MHz-to-20MHz (Non-DC-Balanced) Operation (MAX9246)**
- ♦ **Rising-Edge (MAX9242) or Falling-Edge (MAX9244/MAX9246) Output Strobe**
- ♦ **High-Impedance Outputs when $\overline{\text{PWRDWN}}$ is Low Allow Output Busing**
- ♦ **Fail-Safe Inputs in Non-DC-Balanced Mode**
- ♦ **Separate Output Supply Allows Interface to +1.8V, +2.5V, +3.3V, and +5V Logic**
- ♦ **LVDS Inputs Meet ISO 10605 ESD Protection at ±30kV Air-Gap Discharge and ±6kV Contact Discharge**
- ♦ **LVDS Inputs Meet IEC 61000-4-2 Level 4 ESD Protection at ±15kV Air-Gap Discharge and ±8kV Contact Discharge**
- ♦ **LVDS Inputs Conform to ANSI TIA/EIA-644 Standard**
- ♦ **+3.3V Main Power Supply**

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	PKG CODE
MAX9242EUM	-40°C to +85°C	48 TSSOP	U48-1
MAX9244EUM	-40°C to +85°C	48 TSSOP	U48-1
MAX9246EUM	-40°C to +85°C	48 TSSOP	U48-1

Devices are available in lead-free packaging. Specify lead free by adding a + symbol at the end of the part number when ordering.

Pin Configuration appears at end of data sheet.

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ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND.)
V_{CC}, $LVDSV_{CC}$, $PLLV_{CC}$ .....-0.5V to +4.0V
V_{CCO}.....-0.5V to +6.0V
RxIN_, RxCLKIN_ .....-0.5V to +4.0V
$\overline{PWRDWN}$ .....-0.5V to +6.0V
SSG, DCB.....-0.5V to (V_{CC} + 0.5V)
RxOUT_, RxCLKOUT .....-0.5V to (V_{CCO} + 0.5V)
Continuous Power Dissipation (T_A = +70°C)
48-Pin TSSOP (derate 16mW/°C above +70°C) 1282mW
ESD Protection
Human Body Model (R_D = 1.5kΩ, C_S = 100pF)
All Pins to GND .....±2.5kV
IEC 61000-4-2 (R_D = 330Ω, C_S = 150pF)
LVDS Inputs to GND (Air-Gap Discharge).....±15kV
LVDS Inputs to GND (Contact Discharge).....±8kV
ISO 10605 (R_D = 2.0kΩ, C_S = 330pF)
LVDS Inputs to GND (Air-Gap Discharge).....±30kV
LVDS Inputs to GND (Contact Discharge).....±6kV
Operating Temperature Range .....-40°C to +85°C
Storage Temperature Range .....-65°C to +150°C
Junction Temperature.....+150°C
Lead Temperature (soldering, 10s) .....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(V_{CC} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.0V to +3.6V, V_{CCO} = +3.0V to +5.5V, $\overline{PWRDWN}$ = high; SSG = high, open, or low; DCB = high or low, differential input voltage $|V_{ID}|$ = 0.05V to 1.2V, input common-mode voltage V_{CM} = $|V_{ID}$ / 2| to 2.4V - $|V_{ID}$ / 2|, unless otherwise noted. Typical values are at V_{CC} = V_{CCO} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.3V, $|V_{ID}|$ = 0.2V, V_{CM} = +1.25V, T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
POWER SUPPLY								
Power-Supply Range	V_{CC}, $LVDSV_{CC}$, $PLLV_{CC}$				3.0		3.6	V
Output-Supply Range	V_{CCO}				1.8		5.5	V
Worst-Case Supply Current	I_{CCW}	C_L = 8pF, worst-case pattern, V_{CC} = V_{CCO} = 3.0V to 3.6V, Figure 2 (MAX9242, MAX9244)	DC-balanced mode (SSG = low)	16MHz		45	61	mA
				34MHz		72	96	
			Non-DC-balanced mode (SSG = low)	20MHz		59	79	
				33MHz		80	106	
				40MHz		93	123	
			DC-balanced mode (SSG = high or open)	16MHz		57	78	
				34MHz		93	125	
			Non-DC-balanced mode (SSG = high or open)	20MHz		71	96	
				33MHz		98	129	
				40MHz		115	145	

DC ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.0V to +3.6V, V_{CCO} = +3.0V to +5.5V, $\overline{PWRDWN}$ = high; SSG = high, open, or low; DCB = high or low, differential input voltage $|V_{ID}|$ = 0.05V to 1.2V, input common-mode voltage V_{CM} = $|V_{ID}$ / 2| to 2.4V - $|V_{ID}$ / 2|, unless otherwise noted. Typical values are at V_{CC} = V_{CCO} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.3V, $|V_{ID}|$ = 0.2V, V_{CM} = +1.25V, T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
Worst-Case Supply Current	I_{CCW}	C_L = 8pF, worst-case pattern, V_{CC} = V_{CCO} = 3.0V to 3.6V, Figure 2 (MAX9246)	DC-balanced mode (SSG = low)	6MHz		27	41	mA
				8MHz		30	45	
				18MHz		43	61	
			Non-DC-balanced mode (SSG = low)	8MHz		33	47	
				10MHz		37	52	
				20MHz		52	73	
			DC-balanced mode (SSG = high or open)	6MHz		32	47	
				8MHz		38	57	
				18MHz		57	81	
			Non-DC-balanced mode (SSG = high or open)	8MHz		41	58	
				10MHz		46	65	
				20MHz		66	92	
Power-Down Supply Current	I_{CCZ}	$\overline{PWRDWN}$ = low					50	µA
5V-TOLERANT LOGIC INPUT ($\overline{PWRDWN}$)								
High-Level Input Voltage	V_{IH}				2.0		5.5	V
Low-Level Input Voltage	V_{IL}				-0.3		+0.8	V
Input Current	I_{IN}	$\overline{PWRDWN}$ = high or low level			-20		+20	µA
Input Clamp Voltage	V_{CL}	I_{CL} = -18mA			-1.5			V
THREE-LEVEL LOGIC INPUTS (DCB, SSG)								
High-Level Input Voltage	V_{IH}				2.5		V_{CC} + 0.3	V
Mid-Level Input Current	I_{IM}	DCB, SSG open or connected to a driver with output in high-impedance state (Note 3)			-10		+10	µA
Low-Level Input Voltage	V_{IL}				-0.3		+0.8	V
Input Current	I_{IN}	DCB, SSG = high or low level, $\overline{PWRDWN}$ = high or low			-20		+20	µA
Input Clamp Voltage	V_{CL}	I_{CL} = -18mA			-1.5			V
SINGLE-ENDED OUTPUTS (RxOUT_, RxCLKOUT)								
High-Level Output Voltage	V_{OH}	I_{OH} = -100µA			V_{CCO} - 0.1			V
		I_{OH} = -2mA	RxCLKOUT (Note 4)		V_{CCO} - 0.25			
			RxOUT_		V_{CCO} - 0.43			
Low-Level Output Voltage	V_{OL}	I_{OL} = 100µA					0.1	V
		I_{OL} = 2mA	RxCLKOUT (Note 4)				0.2	
			RxOUT_				0.26	

21-Bit Deserializers with Programmable Spread Spectrum and DC Balance

DC ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.0V to +3.6V, V_{CCO} = +3.0V to +5.5V, $\overline{PWRDWN}$ = high; SSG = high, open, or low; DCB = high or low, differential input voltage $|V_{ID}|$ = 0.05V to 1.2V, input common-mode voltage V_{CM} = $|V_{ID}$ / 2| to 2.4V - $|V_{ID}$ / 2|, unless otherwise noted. Typical values are at V_{CC} = V_{CCO} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.3V, $|V_{ID}|$ = 0.2V, V_{CM} = +1.25V, T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
High-Impedance Output Current	I_{OZ}	$\overline{PWRDWN}$ = low, V_{OUT} = -0.3V to (V_{CCO} + 0.3V)		-30		+30	µA
Output Short-Circuit Current (Note 5)	I_{OS}	V_{CCO} = 3.0V to 3.6V, V_{OUT} = 0V	RxCLKOUT (Note 4)	-10		-40	mA
			RxOUT_	-5		-20	
		VCCO = 4.5V to 5.5V, VOUT = 0V	RxCLKOUT (Note 4)	-28		-75	
			RxOUT_	-13		-37	
LVDS INPUTS (RxIN_, RxCLKIN_)							
Differential Input High Threshold	V_{TH}	(Note 6)				50	mV
Differential Input Low Threshold	V_{TL}	(Note 6)		-50			mV
Input Current	I_{IN+}, I_{IN-}	$\overline{PWRDWN}$ = high or low		-25		+25	µA
Power-Off Input Current	I_{INO+}, I_{INO-}	V_{CC} = V_{CCO} = 0V or open		-40		+40	µA
Input Resistor 1	R_{IN1}	$\overline{PWRDWN}$ = high or low, V_{CC} = V_{CCO} = 0V or open, Figure 1		42		78	kΩ
Input Resistor 2	R_{IN2}	$\overline{PWRDWN}$ = high or low, V_{CC} = V_{CCO} = 0V or open, Figure 1		246		410	kΩ

AC ELECTRICAL CHARACTERISTICS

(V_{CC} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.0V to +3.6V, V_{CCO} = +3.0V to +3.6V, C_L = 8pF, $\overline{PWRDWN}$ = high; SSG = high, open, or low; DCB = high or low, differential input voltage $|V_{ID}|$ = 0.1V to 1.2V, input common-mode voltage V_{CM} = $|V_{ID}$ / 2| to 2.4V - $|V_{ID}$ / 2|, unless otherwise noted. Typical values are at V_{CC} = V_{CCO} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.3V, $|V_{ID}|$ = 0.2V, V_{CM} = +1.25V, T_A = +25°C.) (Notes 6, 7, 8)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Output Rise Time	CLHT	0.1 x V_{CCO} to 0.9 x V_{CCO}, Figure 3	RxOUT_	2.9	4.7	6.5	ns
			RxCLKOUT	2.0	3.3	4.1	
Output Fall Time	CHLT	0.9 x V_{CCO} to 0.1 x V_{CCO}, Figure 3	RxOUT_	2.1	3.0	4.2	ns
			RxCLKOUT	1.10	1.94	2.70	
RxIN Skew Margin (Note 9)	RSKM	DC-balanced mode, Figure 4	16MHz	2560	3142		ps
			34MHz	900	1386		
		Non-DC-balanced mode, Figure 4	20MHz	2500	3164		
			40MHz	960	1371		
RxCLKOUT High Time	RCOH	Figures 5a, 5b		0.35 x RCOP			ns
RxCLKOUT Low Time	RCOL	Figures 5a, 5b		0.35 x RCOP			ns
RxOUT Setup to RxCLKOUT	RSRC	Figures 5a, 5b		0.3 x RCOP			ns
RxOUT Hold from RxCLKOUT	RHRC	Figures 5a, 5b		0.45 x RCOP			ns
RxCLKIN to RxCLKOUT Delay	RCCD	SSG = low, Figures 6a, 6b		4.5 + (RCIP / 2)	6.5 + (RCIP / 2)	8.2 + (RCIP / 2)	ns

AC ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.0V to +3.6V, V_{CCO} = +3.0V to +3.6V, C_L = 8pF, $\overline{PWRDWN}$ = high; SSG = high, open, or low; DCB = high or low, differential input voltage $|V_{ID}|$ = 0.1V to 1.2V, input common-mode voltage V_{CM} = $|V_{ID}$ / 2| to 2.4V - $|V_{ID}$ / 2|, unless otherwise noted. Typical values are at V_{CC} = V_{CCO} = $LVDSV_{CC}$ = $PLLV_{CC}$ = +3.3V, $|V_{ID}|$ = 0.2V, V_{CM} = +1.25V, T_A = +25°C.) (Notes 6, 7, 8)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Deserializer Phase-Locked-Loop Set	RPLLS	Figure 7				65,600 x RCIP	ns
Deserializer Power-Down Delay	RPDD	Figure 8				100	ns
Deserializer Phase-Locked-Loop Set from SSG Change	RPLLS2	Figure 9				32,800 x RCIP	ns
Spread-Spectrum Output Frequency	$f_{RxCLKOUT}$	SSG = high, Figure 10	Maximum output frequency	$f_{RxCLKIN}$ + 3.6%	$f_{RxCLKIN}$ + 4.0%	$f_{RxCLKIN}$ + 4.4%	MHz
			Minimum output frequency	$f_{RxCLKIN}$ - 4.4%	$f_{RxCLKIN}$ - 4.0%	$f_{RxCLKIN}$ - 3.6%	
		SSG = open, Figure 10	Maximum output frequency	$f_{RxCLKIN}$ + 1.8%	$f_{RxCLKIN}$ + 2.0%	$f_{RxCLKIN}$ + 2.2%	
			Minimum output frequency	$f_{RxCLKIN}$ - 2.2%	$f_{RxCLKIN}$ - 2.0%	$f_{RxCLKIN}$ - 1.8%	
		SSG = low		$f_{RxCLKIN}$		$f_{RxCLKIN}$	
Spread-Spectrum Modulation Frequency	f_{SSM}	Figure 10			$f_{RxCLKIN}$ / 1016		Hz

Note 1: Current into a pin is defined as positive. Current out of a pin is defined as negative. All voltages are referenced to ground, except V_{TH} and V_{TL}.

Note 2: Maximum and minimum limits over temperature are guaranteed by design and characterization. Devices are production tested at T_A = +25°C.

Note 3: To provide a mid level, leave the input open, or, if driven, put driver in high impedance. High-impedance leakage current must be less than ±10µA.

Note 4: RxCLKOUT limits are scaled based on RxOUT_ measurements, design, and characterization data.

Note 5: One output shorted at a time. Current out of the pin.

Note 6: V_{TH}, V_{TL}, and AC parameters are guaranteed by design and characterization, and are not production tested. Limits are set at ±6 sigma.

Note 7: C_L includes probe and test jig capacitance.

Note 8: RCIP is the period of RxCLKIN. RCOP is the period of RxCLKOUT.

Note 9: RSKM is measured with less than 150ps cycle-to-cycle jitter on RxCLKIN.

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Test Circuits/Timing Diagrams

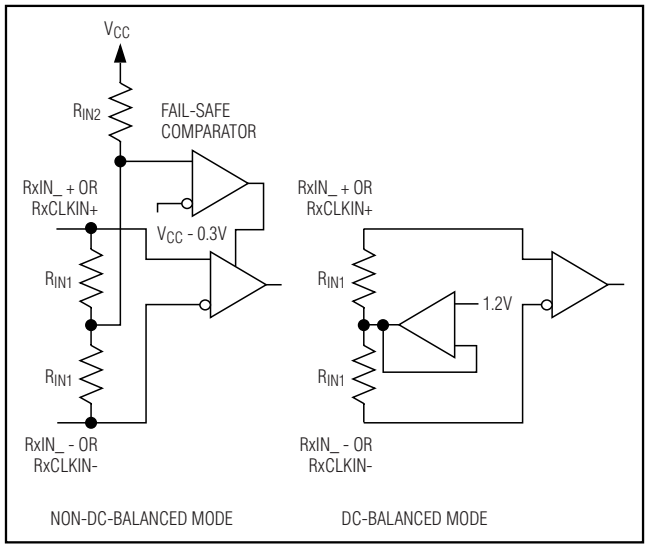


Figure 1. LVDS Input Circuits

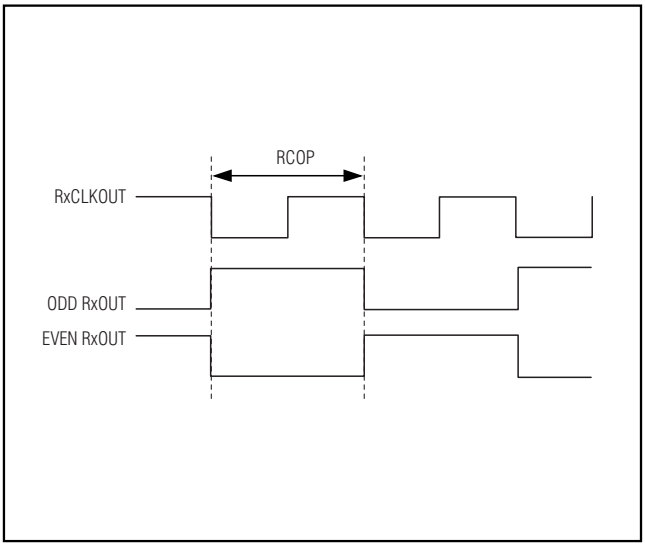


Figure 2. Worst-Case Test Pattern

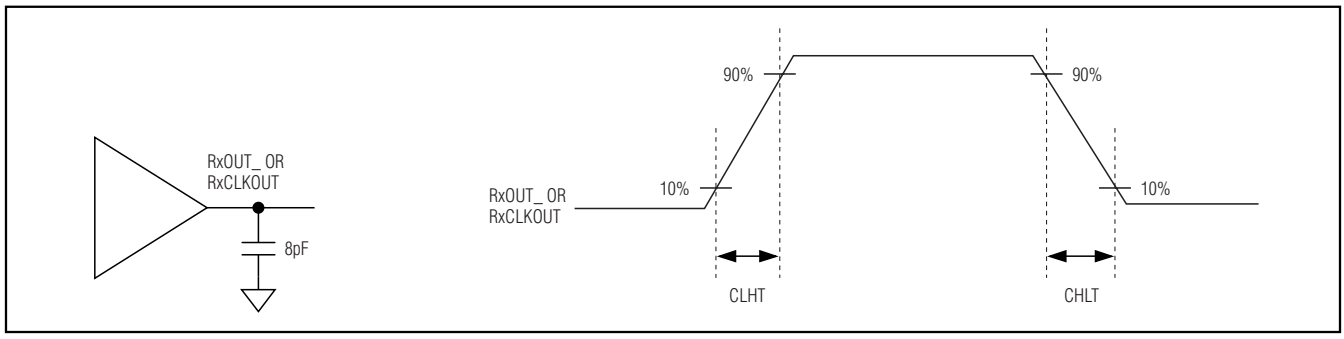


Figure 3. Output Load and Transition Times

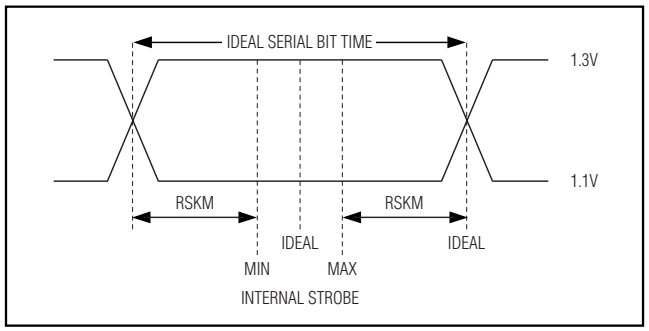


Figure 4. LVDS Receiver Input Skew Margin

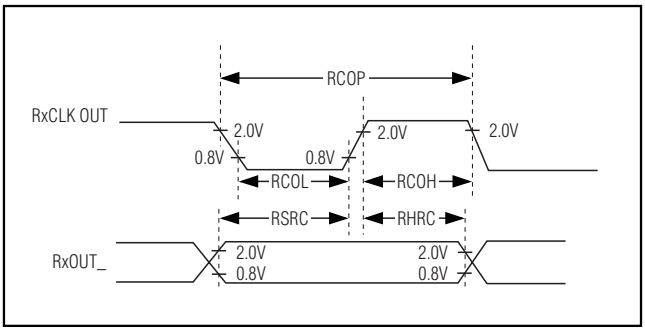


Figure 5a. Rising-Edge Output Setup/Hold and High/Low Times

Test Circuits/Timing Diagrams (continued)

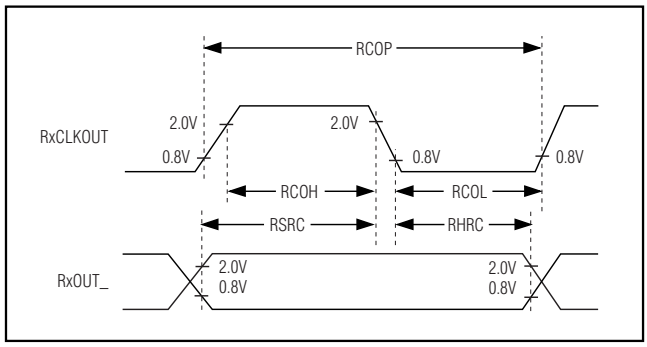


Figure 5b. Falling-Edge Output Setup/Hold and High/Low Times

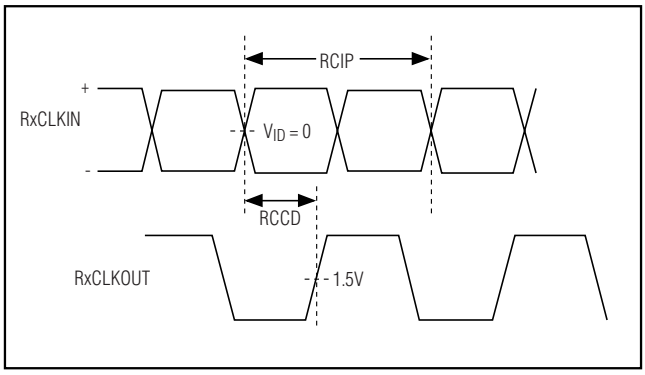


Figure 6b. Clock-IN to Clock-OUT Delay (MAX9242)

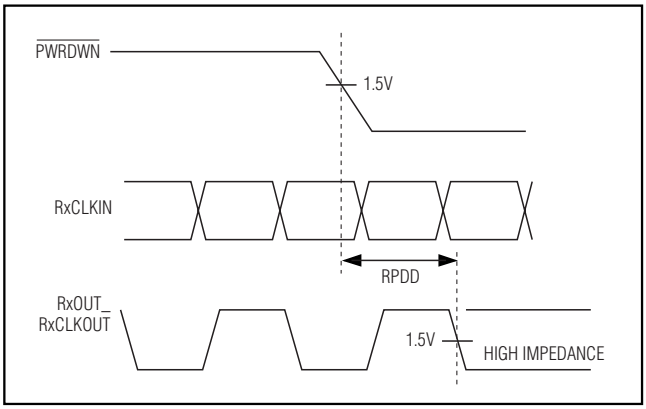


Figure 8. Power-Down Delay

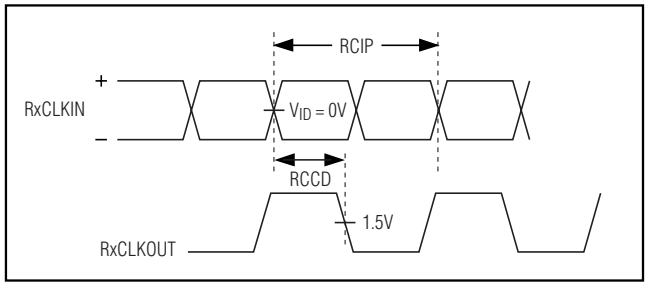


Figure 6a. Clock-IN to Clock-OUT Delay (MAX9244/MAX9246)

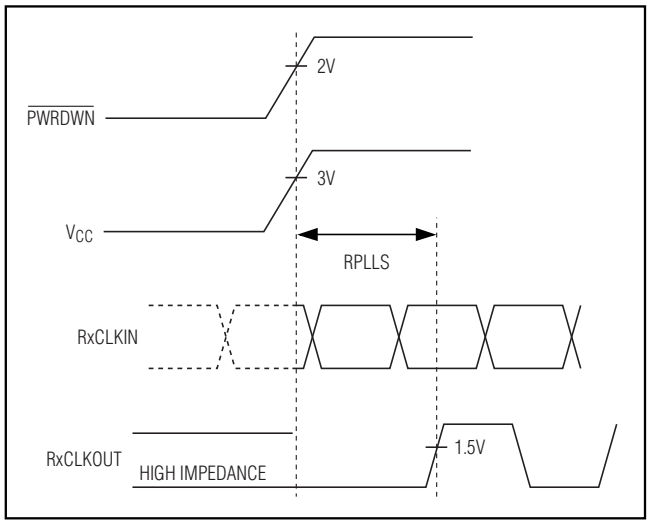


Figure 7. Phase-Locked-Loop Set Time

21-Bit Deserializers with Programmable Spread Spectrum and DC Balance

Test Circuits/Timing Diagrams (continued)

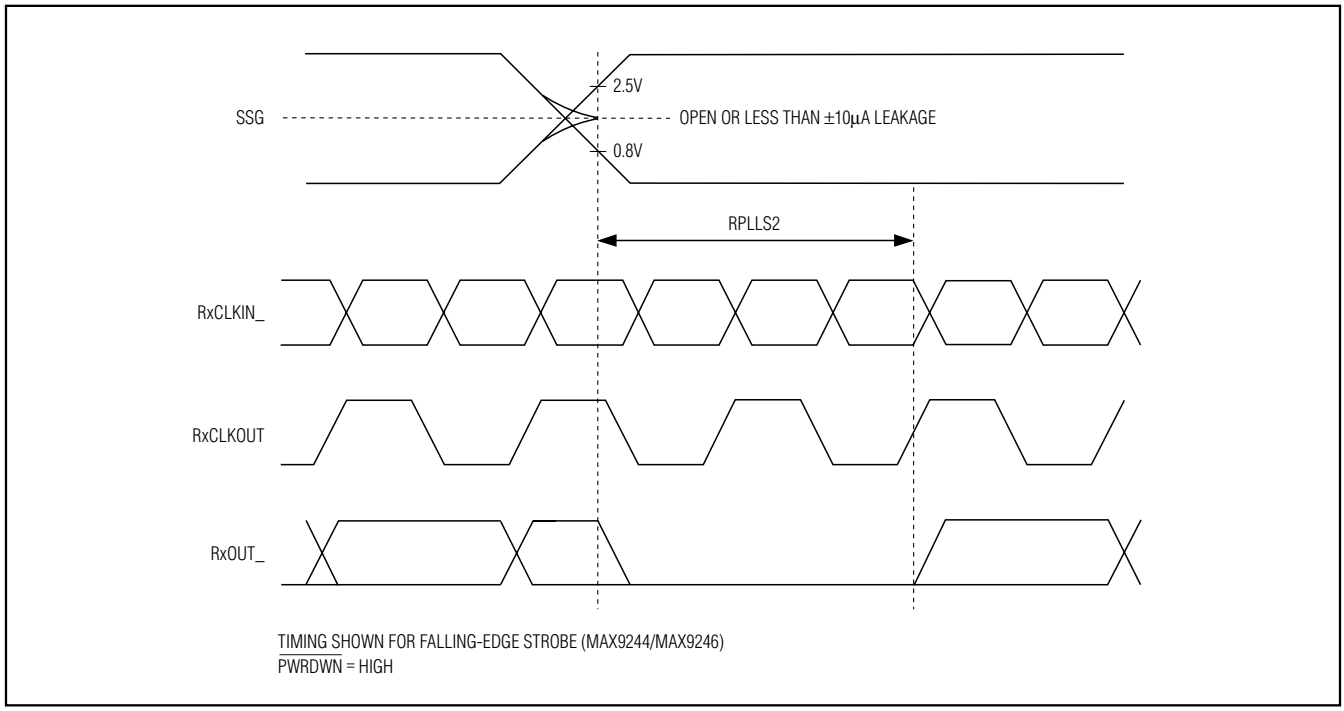


Figure 9. Phase-Locked-Loop Set Time from SSG Change

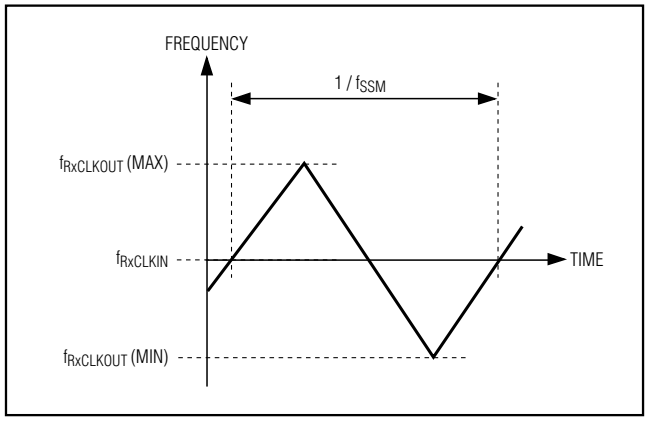
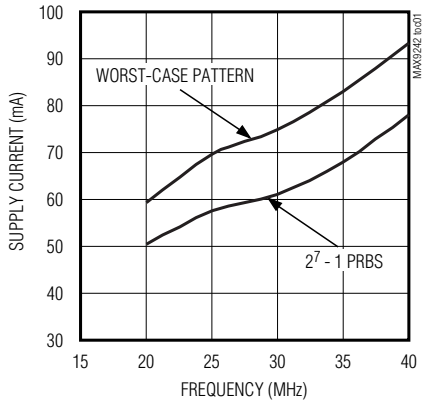


Figure 10. Simplified Modulation Profile

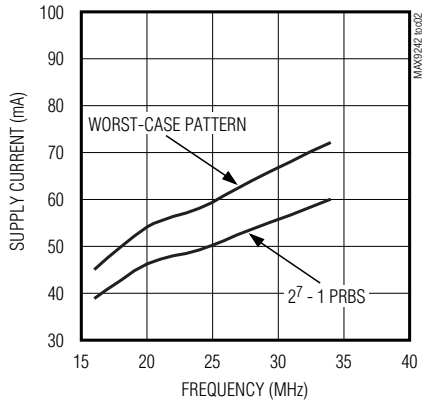
Typical Operating Characteristics

(V_{CC} = $PLLV_{CC}$ = $LVDSV_{CC}$ = V_{CCO} = +3.3V, C_L = 8pF, $\overline{PWRDWN}$ = high, differential input voltage $|V_{ID}|$ = 0.2V, input common-mode voltage V_{CM} = 1.2V, T_A = +25°C, MAX9244, unless otherwise noted.)

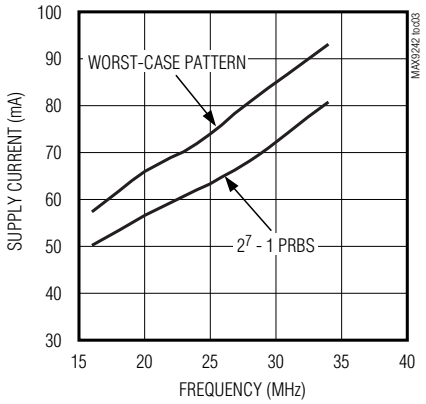
WORST-CASE AND PRBS SUPPLY CURRENT vs. FREQUENCY (NON-DC-BALANCED MODE, NO SPREAD)



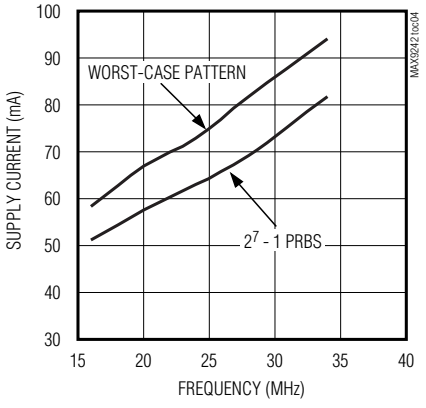
WORST-CASE AND PRBS SUPPLY CURRENT vs. FREQUENCY (DC-BALANCED MODE, NO SPREAD)



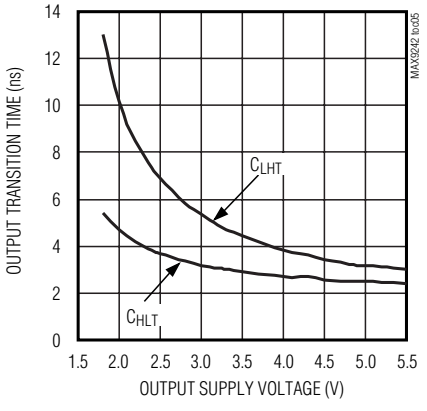
WORST-CASE AND PRBS SUPPLY CURRENT vs. FREQUENCY (DC-BALANCED MODE, 2% SPREAD)



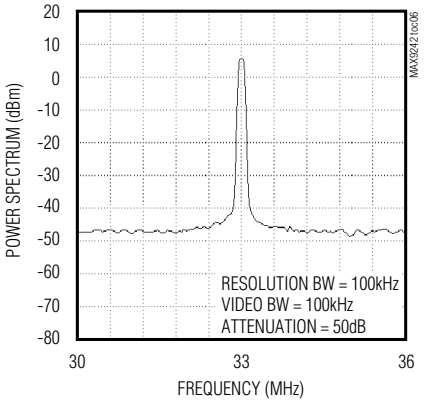
WORST-CASE AND PRBS SUPPLY CURRENT vs. FREQUENCY (DC-BALANCED MODE, 4% SPREAD)



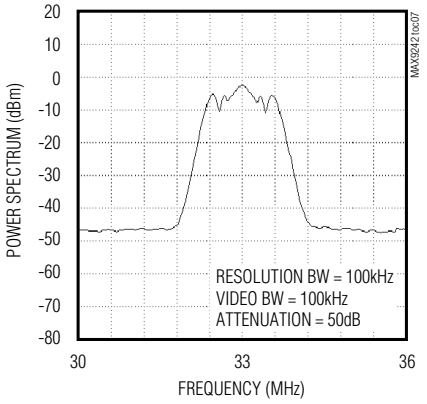
RxOUT_TRANSITION TIME vs. OUTPUT SUPPLY VOLTAGE (V_{CCO})



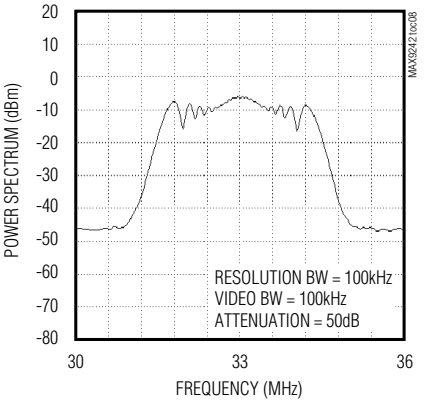
RxCLKOUT POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 33MHz, NO SPREAD)



RxCLKOUT POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 33MHz, 2% SPREAD)



RxCLKOUT POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 33MHz, 4% SPREAD)

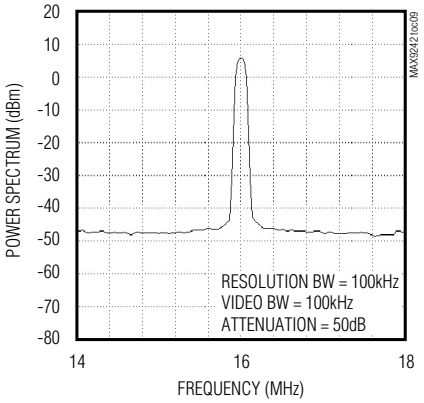


21-Bit Deserializers with Programmable Spread Spectrum and DC Balance

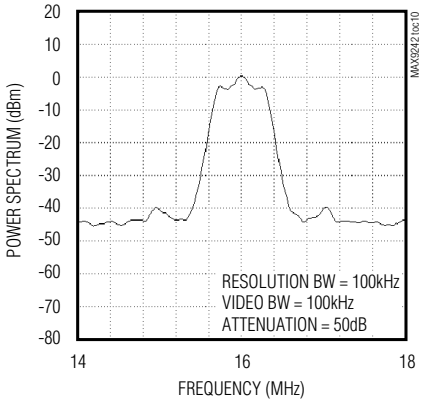
Typical Operating Characteristics (continued)

(V_{CC} = $PLLV_{CC}$ = $LVDSV_{CC}$ = V_{CCO} = +3.3V, C_L = 8pF, $\overline{PWRDWN}$ = high, differential input voltage $|V_{ID}|$ = 0.2V, input common-mode voltage V_{CM} = 1.2V, T_A = +25°C, MAX9244, unless otherwise noted.)

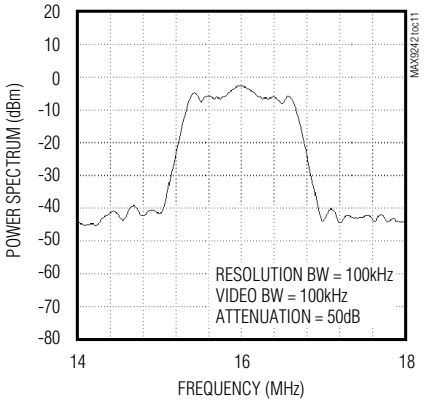
RxCLKOUT POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 16MHz, NO SPREAD)



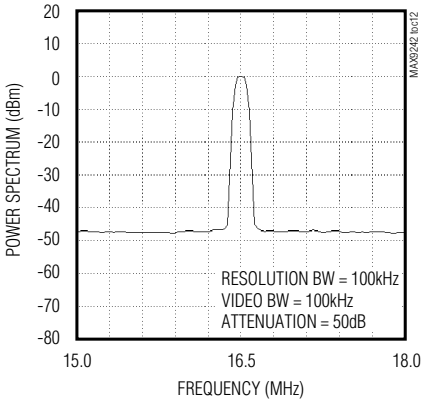
RxCLKOUT POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 16MHz, 2% SPREAD)



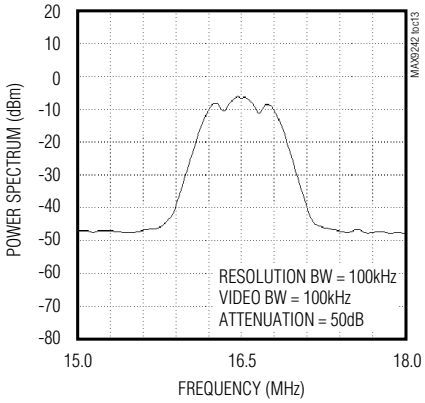
RxCLKOUT POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 16MHz, 4% SPREAD)



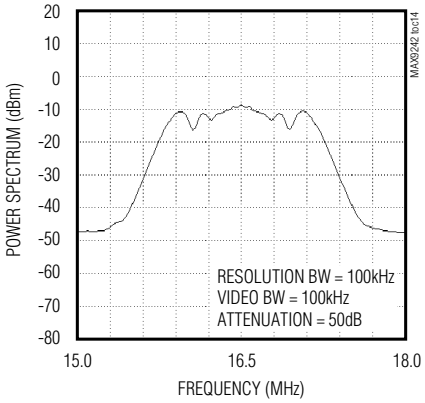
RxOUT_ POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 33MHz, NO SPREAD)



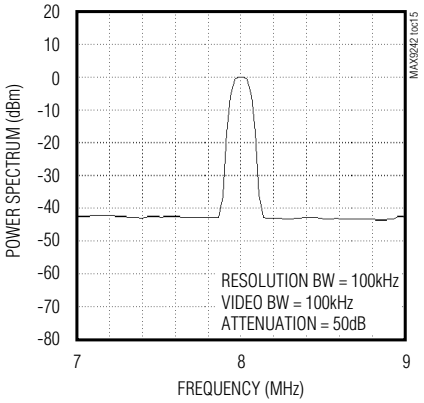
RxOUT_ POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 33MHz, 2% SPREAD)



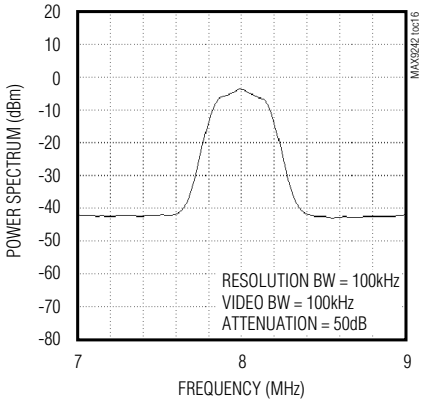
RxOUT_ POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 33MHz, 4% SPREAD)



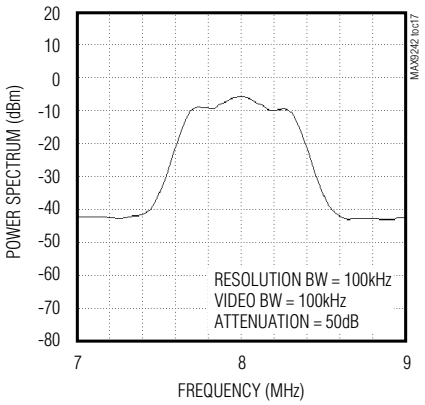
RxOUT_ POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 16MHz, NO SPREAD)



RxOUT_ POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 16MHz, 2% SPREAD)



RxOUT_ POWER SPECTRUM vs. FREQUENCY (RxCLKIN_ = 16MHz, 4% SPREAD)



Pin Description

PIN	NAME	FUNCTION
1	RxOUT17	Channel 2 Single-Ended Outputs
2	RxOUT18	
3, 25, 32, 38, 44	GND	Ground
4	RxOUT19	Channel 2 Single-Ended Outputs
5	RxOUT20	
6	SSG	Three-Level-Logic, Spread-Spectrum Generator Control Input. SSG selects the frequency spread of RxCLKOUT relative to RxCLKIN (see Table 3).
7	DCB	Three-Level-Logic, DC-Balance Control Input. DCB selects DC-balanced, non-DC-balanced, or reserved operation (see Table 1).
8	RxIN0-	Inverting Channel 0 LVDS Serial-Data Input
9	RxIN0+	Noninverting Channel 0 LVDS Serial-Data Input
10	RxIN1-	Inverting Channel 1 LVDS Serial-Data Input
11	RxIN1+	Noninverting Channel 1 LVDS Serial-Data Input
12	$LVDSV_{CC}$	LVDS Supply Voltage. Bypass $LVDSV_{CC}$ to GND with 0.1µF and 0.001µF capacitors in parallel as close to the pin as possible.
13, 18	LVDSGND	LVDS Ground
14	RxIN2-	Inverting Channel 2 LVDS Serial-Data Input
15	RxIN2+	Noninverting Channel 2 LVDS Serial-Data Input
16	RxCLKIN-	Inverting LVDS Parallel-Rate Clock Input
17	RxCLKIN+	Noninverting LVDS Parallel-Rate Clock Input
19, 21	PLLGND	PLL Ground
20	$PLLV_{CC}$	PLL Supply Voltage. Bypass $PLLV_{CC}$ to GND with 0.1µF and 0.001µF capacitors in parallel as close to the pin as possible.
22	$\overline{PWRDWN}$	5V-Tolerant LVTTL/LVCMOS Power-Down Input. $\overline{PWRDWN}$ is internally pulled down to GND. Outputs are high impedance when $\overline{PWRDWN}$ = low or open.
23	RxCLKOUT	Parallel-Rate Clock Single-Ended Output. The MAX9242 has a rising-edge strobe. The MAX9244/MAX9246 have a falling-edge strobe.
24	RxOUT0	Channel 0 Single-Ended Outputs
26	RxOUT1	
27	RxOUT2	
28, 36, 48	V_{CCO}	Output Supply Voltage. Bypass each V_{CCO} to GND with 0.1µF and 0.001µF capacitors in parallel as close to the pin as possible.
29	RxOUT3	Channel 0 Single-Ended Outputs
30	RxOUT4	
31	RxOUT5	
33	RxOUT6	

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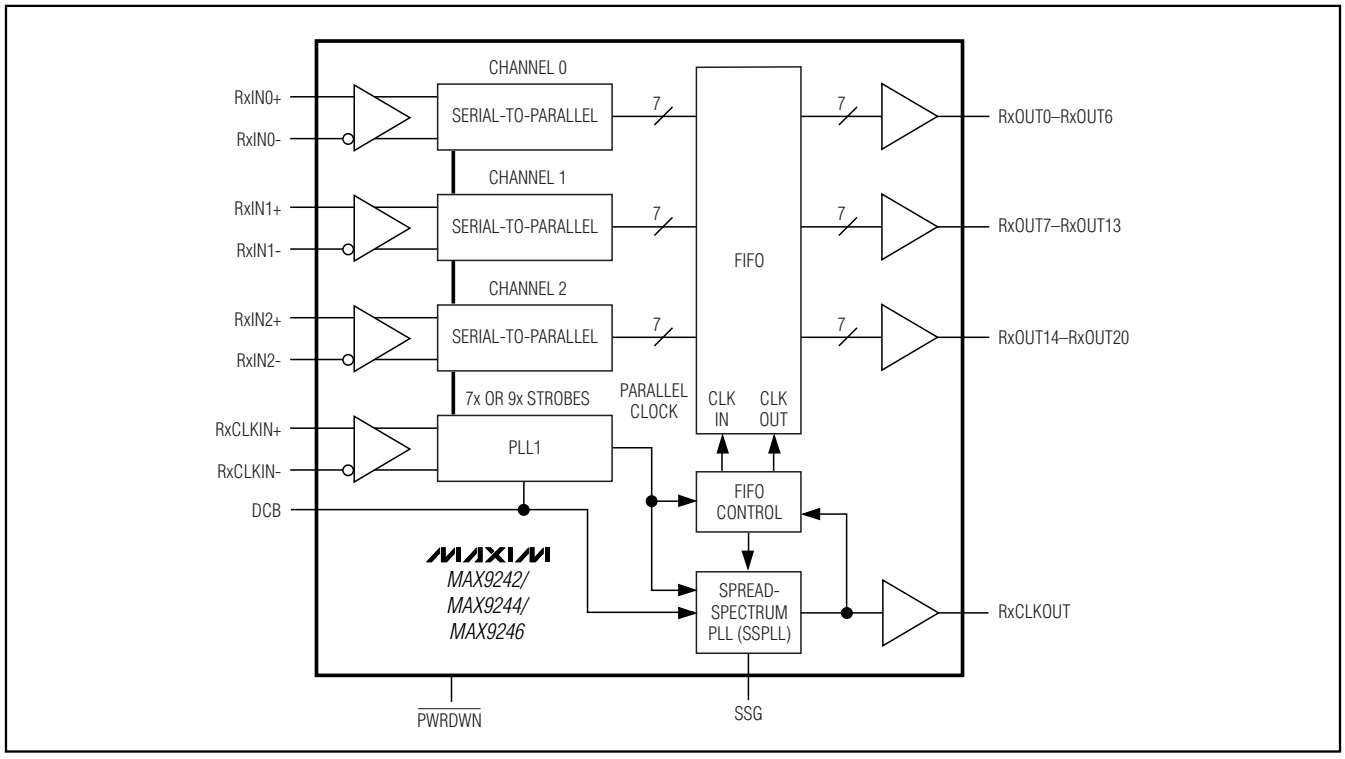
Pin Description (continued)

PIN	NAME	FUNCTION
34	RxOUT7	Channel 1 Single-Ended Outputs
35	RxOUT8	
37	RxOUT9	
39	RxOUT10	
40	RxOUT11	
41	RxOUT12	
42	V_{CC}	Digital Supply Voltage. Bypass V_{CC} to GND with 0.1µF and 0.001µF capacitors in parallel as close to the pin as possible.
43	RxOUT13	Channel 1 Single-Ended Output
45	RxOUT14	Channel 2 Single-Ended Outputs
46	RxOUT15	
47	RxOUT16	

Functional Diagram



Detailed Description

The MAX9242/MAX9244/MAX9246 deserialize three LVDS serial-data inputs into 21 single-ended LVCMOS/LVTTL outputs. The outputs are programmable for no spread or for a spread of ±2% or ±4%, relative to the LVDS input clock frequency. The MAX9242/MAX9244 operate at a parallel clock frequency of 16MHz to 34MHz in DC-balanced mode and 20MHz to 40MHz in non-DC-balanced mode. The MAX9246 operates at a 6MHz-to-18MHz parallel clock frequency in DC-balanced mode and 8MHz-to-20MHz parallel clock frequency in non-DC-balanced mode. DC-balanced or non-DC-balanced operation is controlled by the DCB input. The MAX9242 has a rising-edge strobe and the MAX9244/MAX9246 have a falling-edge strobe.

DC Balance (DCB)

DC-balanced or non-DC-balanced operation is controlled by the DCB input (see Table 1). In the non-DC-balanced mode, each channel deserializes 7 bits every cycle of the parallel clock. In DC-balanced mode, 9 bits are deserialized every clock cycle (7 data bits + 2 DC-balanced bits). The highest serial-data rate on each channel in DC-balanced mode is 34MHz x 9 = 306Mbps. In non-DC-balanced mode, the maximum data rate is 40MHz x 7 = 280Mbps.

Table 1. DCB Function

DCB INPUT LEVEL	FUNCTION
High	Non-DC-balanced mode
Mid	Reserved
Low	DC-balanced mode

Data coding by the MAX9209/MAX9213 serializers (that are companion devices to the MAX9242/MAX9244/MAX9246 deserializers) limits the imbalance of ones and zeros transmitted on each channel. If +1 is assigned to each binary 1 transmitted and -1 is assigned to each binary 0 transmitted, the variation in the running sum of assigned values is called the digital sum variation (DSV). The maximum DSV for the data channels is 10. At most, 10 more zeros than ones, or 10 more ones than zeros, are ever transmitted. The maximum DSV for the clock channel is 5. Limiting the DSV and choosing the correct coupling capacitors maintain differential signal amplitude and reduces jitter due to droop on AC-coupled links.

To obtain DC balance on the data channels, the serializer parallel data is inverted or not inverted, depending on the sign of the digital sum at the word boundary. Two complementary bits are appended to each group of 7 parallel-input data bits to indicate to the MAX9242/MAX9244/MAX9246 deserializer whether the data bits are inverted (see Figures 11 and 12). The deserializer restores the original state of the parallel data. The LVDS clock signal alternates duty cycles of 4/9 and 5/9 to maintain DC balance.

Spread-Spectrum Generator (SSG)

The MAX9242/MAX9244/MAX9246 single-ended data and clock outputs are programmable for a variation of ±2% or ±4% around the LVDS input clock frequency. The modulation rate of the frequency variation is 32.48kHz for a 33MHz LVDS clock input and scales linearly with the input clock frequency (see Table 2). The spread spectrum can also be turned off. The output spread is controlled through the SSG input (see Table 3).

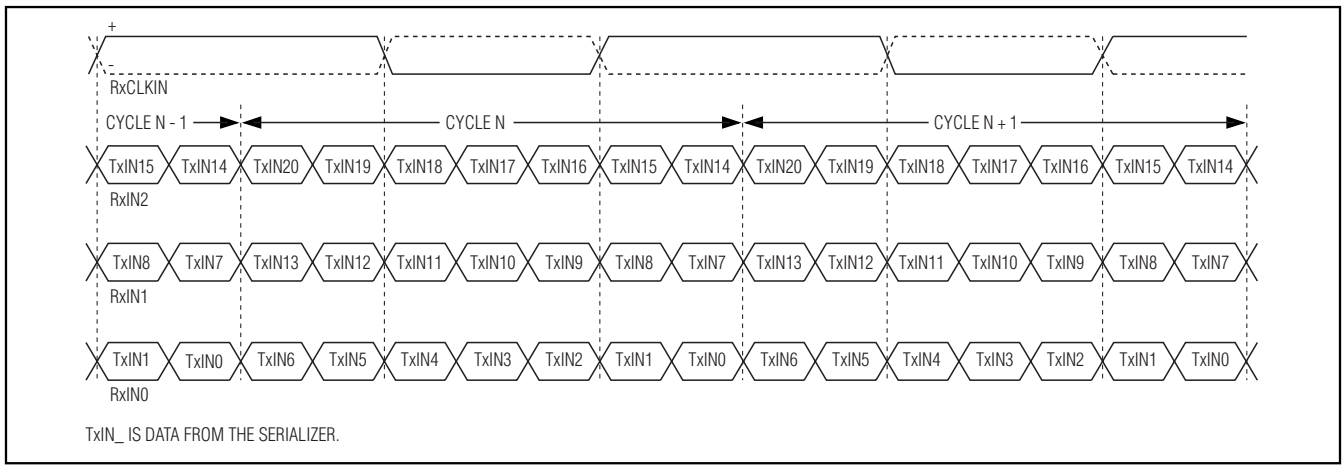


Figure 11. Deserializer Serial Input in Non-DC-Balanced Mode

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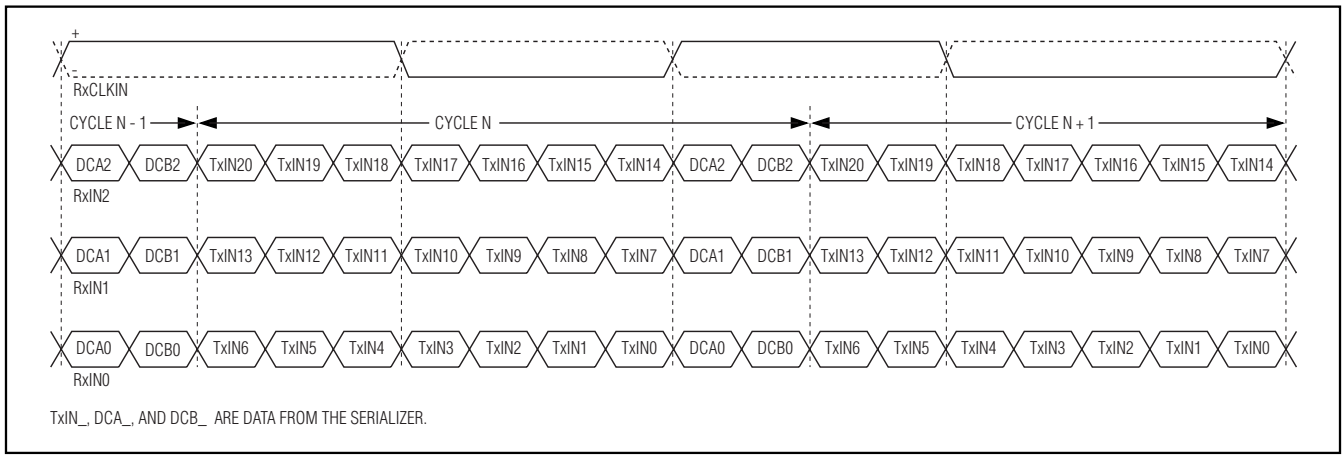

Figure 12. Deserializer Serial Input in DC-Balanced Mode

Table 2. Modulation Rate

$f_{RxCLKIN}$ (MHz)	f_M (kHz) = $f_{RxCLKIN}$ / 1016
6	5.91
8	7.87
10	9.84
16	15.75
18	17.72
20	19.68
33	32.48
34	33.46
40	39.37

Table 3. SSG Function

SSG INPUT LEVEL	FUNCTION
High	RxCLKOUT frequency spread ±4% relative to RxCLKIN
Mid	RxCLKOUT frequency spread ±2% relative to RxCLKIN
Low	No spread on RxCLKOUT relative to RxCLKIN

Note: *RxOUT_ data outputs are spread because RxCLKOUT strobes the output of the FIFO.*

To select the mid level, leave the input open, or if driven, put the driver output in high impedance. The driver high-impedance leakage current must be less than ±10µA.

Any spread change causes a maximum delay time of 32,800 x RCIP before output data is valid. When the spread amount is changed from ±2% to ±4% or vice-versa, the data outputs go low for one delay time (see Figure 13). Similarly, when the spread is changed from no spread to ±2% or ±4%, the data outputs go low for one delay time (see Figure 14). The data outputs continue to switch but are not valid when the spread amount is changed from ±2% or ±4% to no spread (see Figure 15). The spread-spectrum function is also available when the MAX9242/MAX9244/MAX9246 operate in non-DC-balanced mode.

Hot Swap

When the MAX9242/MAX9244/MAX9246 are connected to an active serializer, they synchronize correctly. The PLL control voltage does not saturate in response to high-frequency glitches that may occur during a hot swap. The $\overline{PWRDWN}$ input on the MAX9242/MAX9244/MAX9246 does not need to be cycled when these devices are connected to an active serializer.

PLL Lock Time

The MAX9242/MAX9244/MAX9246 use two PLLs. The first PLL (PLL1) generates a 7x clock (non-DC-balanced mode) or a 9x clock (DC-balanced mode) from RxCLKIN for deserializing the LVDS inputs. The second PLL (SSPLL) is used for spread-spectrum modulation. During initial power-up, the PLL1 locks, and SSPLL locks immediately after. The PLL lock times are set by an internal counter. The maximum time to lock for each PLL is 32,800 clock periods. Power and clock should be stable to meet the lock time specification. After initialization, if the first PLL loses lock, it locks again and then the

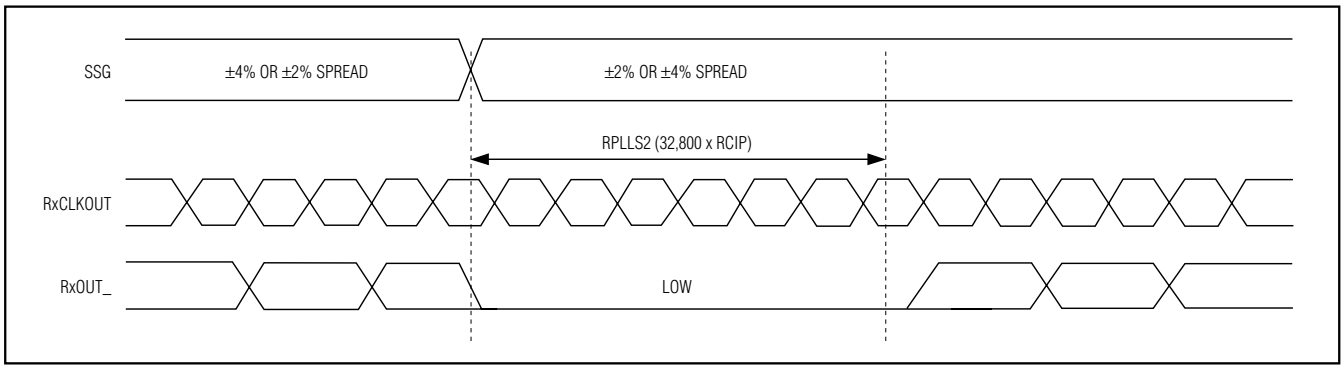

Figure 13. Output Waveforms when Spread Amount is Changed

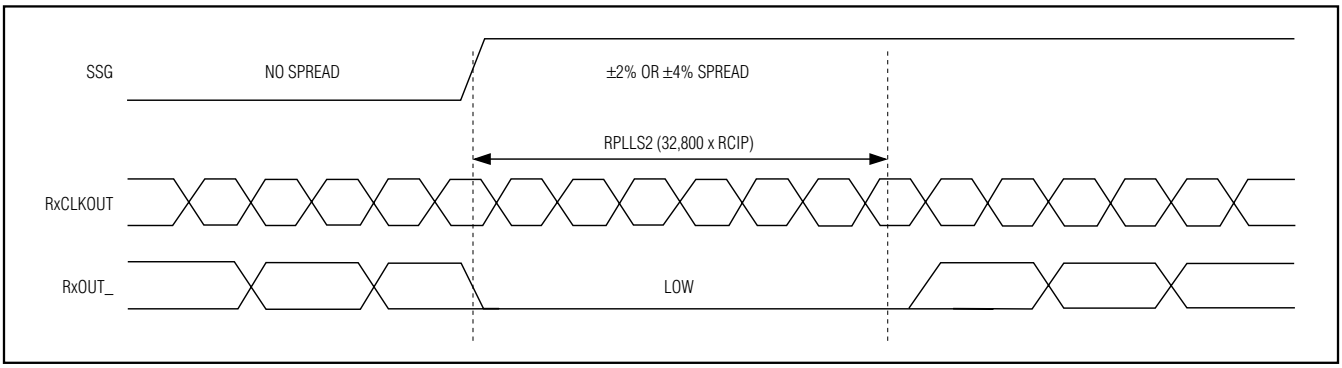

Figure 14. Output Waveforms when Spread is Added

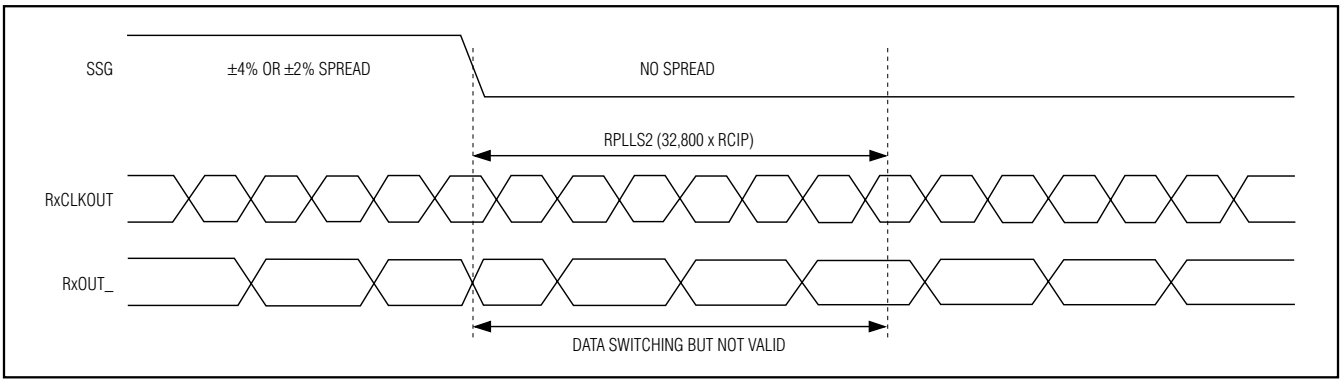

Figure 15. Output Waveforms when Spread is Removed

spread-spectrum PLL locks immediately after (see Figure 16). If the spread-spectrum PLL loses lock, it locks again with only one PLL lock delay (see Figure 17).

AC-Coupling Benefits

Bit errors experienced with DC-coupling (Figure 18) can be eliminated by increasing the receiver common-mode voltage range through AC-coupling. AC-coupling increases the common-mode voltage range of an LVDS receiver to nearly the voltage rating of the capacitor. The typical LVDS driver output is 350mV centered on a 1.25V offset voltage, making single-ended output voltages of 1.425V and 1.075V. An LVDS receiver accepts signals from 0 to 2.4V, allowing approximately ±1V common-mode difference between the driver and receiver on a

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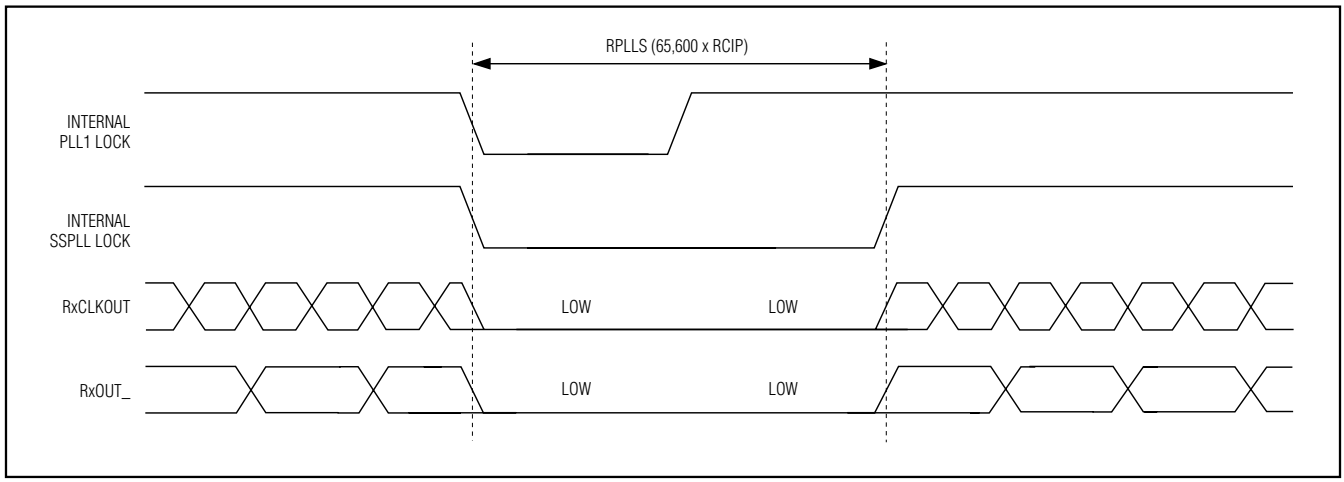

Figure 16. Output Waveforms when PLL1 Loses Lock and Locks Again

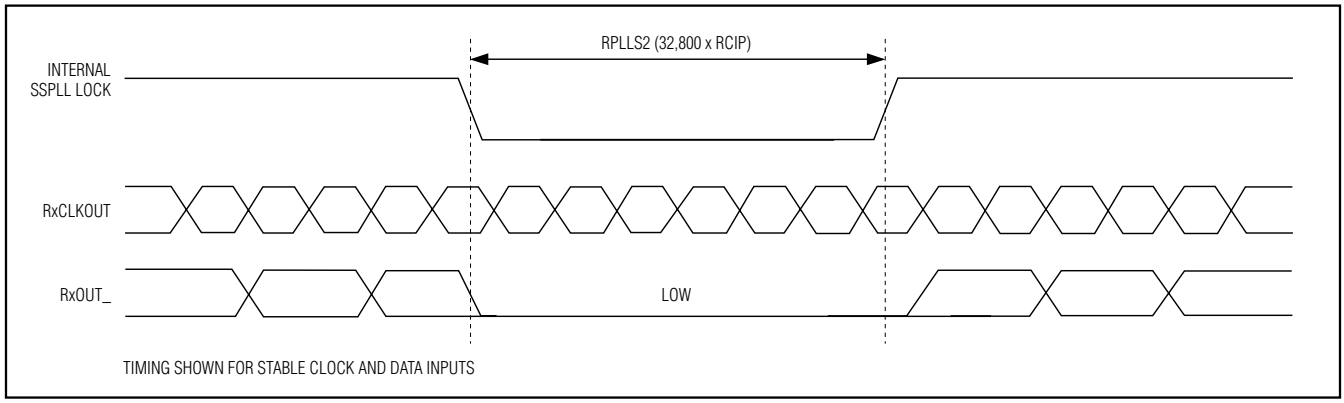

Figure 17. Output Waveforms if Spread-Spectrum PLL Loses Lock and Locks Again

DC-coupled link (2.4V - 1.425V = 0.975V and 1.075V - 0V = 1.075V). Common-mode voltage differences may be due to ground potential variation or common-mode noise. If there is more than ±1V of difference, the receiver is not guaranteed to read the input signal correctly and may cause bit errors. AC-coupling filters low-frequency ground shifts and common-mode noise and passes high-frequency data. A common-mode voltage difference up to the voltage rating of the coupling capacitor (minus half the differential swing) is tolerated. DC-balanced coding of the data is required to maintain the differential signal amplitude and limit jitter on an AC-coupled link. A capacitor in series with each output of the LVDS driver is sufficient for AC-coupling. However, two capacitors—one at the serializer output and one at the deserializer input—provide protection in case either end of the cable is shorted to a high voltage.

Applications Information

Selection of AC-Coupling Capacitors

Voltage droop and the DSV of transmitted symbols cause signal transitions to start from different voltage levels. Because the transition time is finite, starting the signal transition from different voltage levels causes timing jitter. The time constant for an AC-coupled link needs to be chosen to reduce droop and jitter to an acceptable level.

The RC network for an AC-coupled link consists of the LVDS receiver termination resistor (R_T), the LVDS driver output resistor (R_O), and the series AC-coupling capacitors (C). The RC time constant for two equal-value series capacitors is (C x (R_T + R_O)) / 2 (Figure 19). The RC time constant for four equal-value series capacitors is (C x (R_T + R_O)) / 4 (Figure 20).

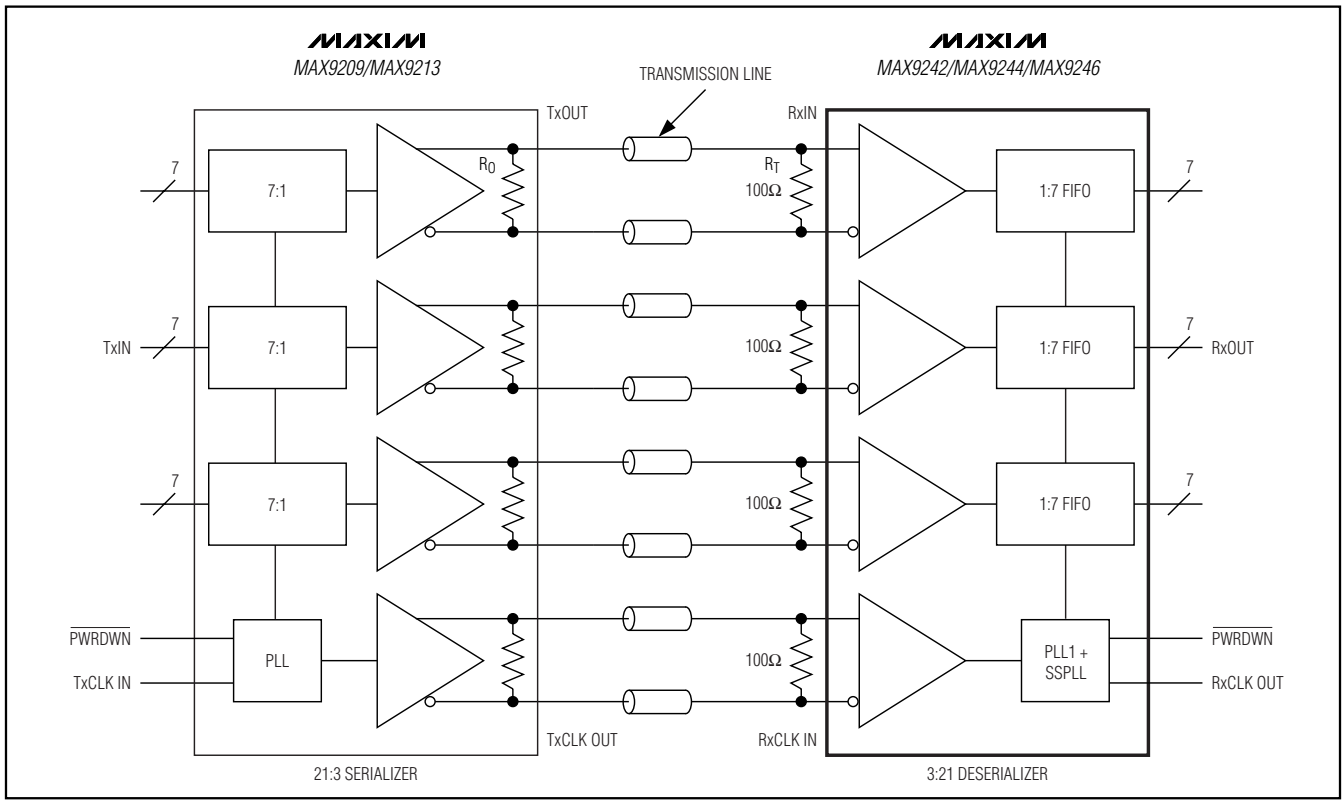

Figure 18. DC-Coupled Link, Non-DC-Balanced Mode

R_T is required to match the transmission line impedance (usually 100Ω) and R_O is determined by the LVDS driver design (the minimum differential output resistance of 78Ω for the MAX9209/MAX9213 serializers is used in the following example). This condition leaves the capacitor selection to change the system time constant.

In the following example, the capacitor value for a 2% droop is calculated. Jitter due to this droop is then calculated assuming a 1ns transition time:

$$C = -(2 \times t_B \times DSV) / (\ln (1 - D) \times (R_T + R_O)) \text{ (Eq 1)}$$

where:
C = AC-coupling capacitor (F)
t_B = bit time (s)
DSV = digital sum variation (integer)
ln = natural log
D = droop (% of signal amplitude)
R_T = termination resistor (Ω)
R_O = output resistance (Ω)

Equation 1 is for two series capacitors (Figure 19). The bit time (t_B) is the period of the parallel clock divided by 9. The DSV is 10. See equation 3 for four series capacitors (Figure 20).

The capacitor for 2% maximum droop at 16MHz parallel rate clock is:

$$C = -(2 \times 6.95ns \times 10) / (\ln (1 - 0.02) \times (100\Omega + 78\Omega))$$

$$C = 0.038\mu F$$

Jitter due to droop is proportional to the droop and transition time:

$$t_J = t_T \times D \text{ (Eq 2)}$$

where:
t_J = jitter (s)
t_T = transition time (s) (0 to 100%)
D = droop (% of signal amplitude)

Jitter due to 2% droop and assumed 1ns transition time is:

$$t_J = 1ns \times 0.02$$

$$t_J = 20ps$$

The transition time in a real system depends on the frequency response of the cable driven by the serializer.

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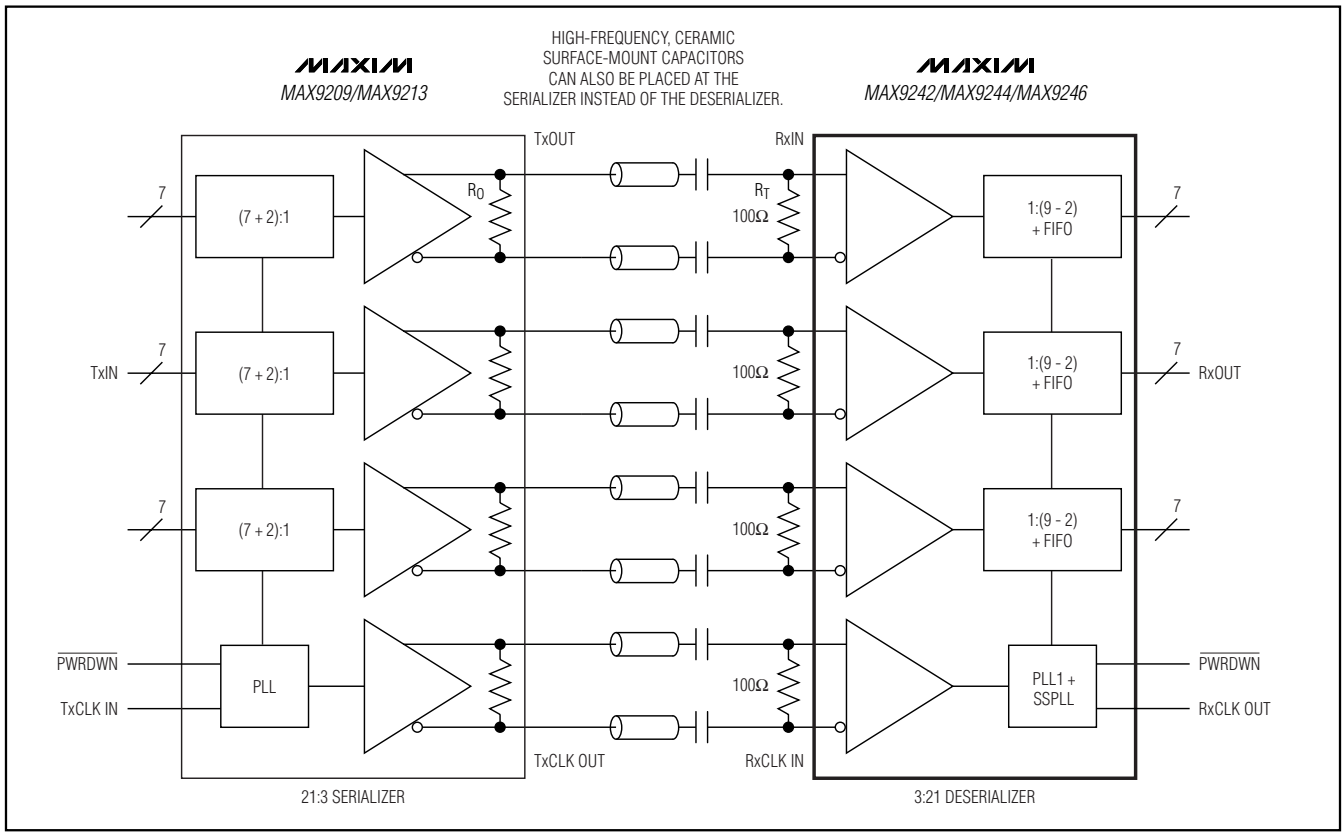


Figure 19. Two Capacitors per Link, AC-Coupled, DC-Balanced Mode

The capacitor value decreases for a higher frequency parallel clock and for higher levels of droop and jitter. Use high-frequency, surface-mount ceramic capacitors.

Equation 1 altered for four series capacitors (Figure 20) is:

$$C = -(4 \times t_B \times DSV) / (\ln (1 - D) \times (R_T + R_O)) \quad \text{(Eq 3)}$$

Fail-Safe

The MAX9242/MAX9244/MAX9246 have fail-safe LVDS inputs in non-DC-balanced mode (Figure 1). Fail-safe drives the outputs low when the corresponding LVDS input is open, undriven and shorted, or undriven and parallel terminated. The fail-safe on the LVDS clock input drives all outputs low when power is stable. Fail-safe does not operate in DC-balanced mode.

Input Bias and Frequency Detection

In DC-balanced mode, the inverting and noninverting LVDS inputs are internally connected to +1.2V through 42kΩ (min) to provide biasing for AC-coupling (Figure 1). To prevent switching due to noise when the clock input is not driven, bias the clock inputs (RxCLKIN+, RxCLKIN-) to differential +15mV by connecting a 10kΩ ±1% pullup resistor between the noninverting input and $LVDSV_{CC}$, and a 10kΩ ±1% pulldown resistor between the inverting input and ground. These bias resistors, along with the 100Ω ±1% tolerant termination resistor, provide +15mV of differential input. The +15mV bias causes some small degradation of RSKM proportional to the slew rate of the clock input. For example, if the clock transitions 250mV in 500ps, the slew rate of 0.5mV/ps reduces RSKM by 30ps.

Unused LVDS Data Inputs

In non-DC-balanced mode, leave unused LVDS data inputs open. In non-DC-balanced mode, the input fail-safe circuit drives the corresponding outputs low, and no pullup or pulldown resistors are needed. In DC-balanced mode, at each unused LVDS data input, pull the inverting input up to $LVDSV_{CC}$ using a 10kΩ resistor, and pull the noninverting input down to ground using a 10kΩ resistor. Do not connect a termination resistor. The pullup and pulldown resistors drive the corresponding outputs low and prevent switching due to noise.

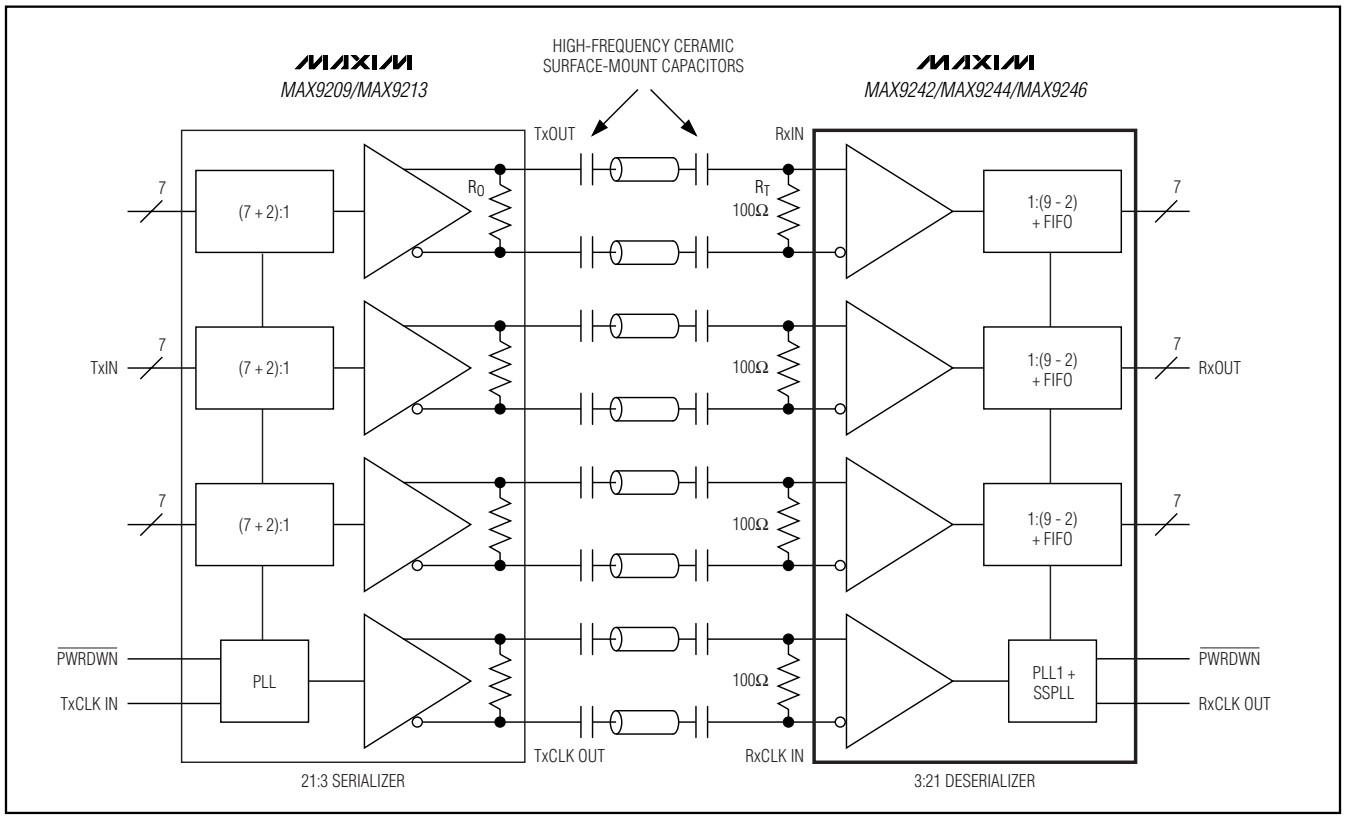


Figure 20. Four Capacitors per Link, AC-Coupled, DC-Balanced Mode

Link Power-Up Sequence

The recommended link power-up sequence is to power up the serializer, wait until the serializer PLL locks, and then power up the deserializer. This sequence prevents the deserializer from seeing an undriven or unstable input when powering up.

$\overline{\text{PWRDWN}}$

Driving $\overline{\text{PWRDWN}}$ low puts the outputs in high impedance, stops the PLL, and reduces supply current to 50µA or less. Driving $\overline{\text{PWRDWN}}$ high drives the outputs low until the PLL locks. The outputs of two deserializers can be bused to form a 2:1 mux with the outputs controlled by $\overline{\text{PWRDWN}}$. Wait 100ns between disabling one deserializer (driving $\overline{\text{PWRDWN}}$ low) and enabling the second one (driving $\overline{\text{PWRDWN}}$ high) to avoid contention of the bused outputs.

Power-Supply Bypassing

There are separate on-chip power domains for digital circuits, outputs, PLL, and LVDS inputs. Bypass each V_{CC}, V_{CCO}, $PLLV_{CC}$, and $LVDSV_{CC}$ with high-frequency, surface-mount ceramic 0.1µF and 0.001µF capacitors in parallel as close to the device as possible, with the smallest value capacitor closest to the supply pin.

Cables and Connectors

Interconnect for LVDS typically has a differential impedance of 100Ω. Use cables and connectors that have matched differential impedance to minimize impedance discontinuities.

Twisted-pair and shielded twisted-pair cables offer superior signal quality compared to ribbon cable and tend to generate less EMI due to magnetic field canceling effects. Balanced cables pick up noise as common mode, which is rejected by the LVDS receiver.

Board Layout

Keep the LVTTL/LVCMOS outputs and LVDS input signals separated to prevent crosstalk. A four-layer PC board with separate layers for power, ground, LVDS inputs, and digital signals is recommended. Layout PC board traces for 100Ω differential characteristic impedance. The trace dimensions depend on the type of

21-Bit Deserializers with Programmable Spread Spectrum and DC Balance

trace used (microstrip or stripline). Note that two 50Ω PC board traces do not have 100Ω differential impedance when brought close together—the impedance goes down when the traces are brought closer.

Route the PC board traces for an LVDS channel (there are two conductors per LVDS channel) in parallel to maintain the differential characteristic impedance. Place the termination resistor at the end of the PC board traces within a 1/4 inch of the LVDS receiver input. Avoid vias. If vias must be used, use only one pair per LVDS channel and place the via for each line at the same point along the length of the PC board traces. This way, any reflections will occur at the same time. Do not make vias into test points for ATE. Make LVDS clock and data pairs the same length on the PC board to avoid pair-to-pair skew. Make the PC board traces that make up a differential pair the same length to avoid skew within the differential pair.

5V-Tolerant Input

$\overline{PWRDWN}$ is 5V tolerant and is internally pulled down to GND. SSG and DCB are not 5V tolerant. The input voltage range for SSG and DCB is nominally ground to V_{CC}.

Skew Margin (RSKM)

Skew margin (RSKM) is the time allowed for degradation of the serial-data sampling setup and hold times by sources other than the deserializer. The deserializer sampling uncertainty is accounted for and does not need to be subtracted from RSKM. The main outside contributors of jitter and skew that subtract from RSKM are interconnect intersymbol interference, serializer pulse position uncertainty, and pair-to-pair path skew.

V_{CCO} Output Supply and Power Dissipation

The outputs have a separate supply (V_{CCO}) for interfacing to systems with 1.8V to 5V nominal input logic levels. The *DC Electrical Characteristics* table gives the maximum supply current for V_{CCO} = 3.6V with 8pF load at several switching frequencies with all outputs switching in the worst-case switching pattern. The approximate incremental supply current for V_{CCO} other than 3.6V with the same 8pF load and worst-case pattern can be calculated using:

$$I_I = C_T V_I\, 0.5 f_C \times 21 \text{ (data outputs)} + C_T V_I f_C \times 1 \text{ (clock output)}$$

where:

I_I = incremental supply current
C_T = total internal (C_{INT}) and external (C_L) load capacitance
V_I = incremental supply voltage
f_C = output clock switching frequency

The incremental current is added to (for V_{CCO} > 3.6V) or subtracted from (for V_{CCO} < 3.6V) the *DC Electrical Characteristics* table maximum supply current. The internal output buffer capacitance is C_{INT} = 6pF. The worst-case pattern switching frequency of the data outputs is half the switching frequency of the output clock.

In the following example, the incremental supply current of the MAX9244 in spread and DC-balanced mode is calculated for V_{CCO} = 5.5V, f_C = 34MHz, and C_L = 8pF:

$$V_I = 5.5V - 3.6V = 1.9V$$

$$C_T = C_{INT} + C_L = 6pF + 8pF = 14pF$$

where:

$I_I = C_T V_I\, 0.5 f_C \times 21$ (data outputs) + $C_T V_I f_C \times 1$ (clock output)

I_I = (14pF x 1.9V x 0.5 x 34MHz x 21) + (14pF x 1.9V x 34MHz)

I_I = 9.5mA + 0.9mA = 10.4mA.

The maximum supply current in DC-balanced mode for V_{CC} = V_{CCO} = 3.6V at f_C = 34MHz is 125mA (from the *DC Electrical Characteristics* table). Add 10.4mA to get the total approximate maximum supply current at V_{CCO} = 5.5V and V_{CC} = 3.6V.

If the output supply voltage is less than V_{CCO} = 3.6V, the reduced supply current can be calculated using the same formula and method.

At high switching frequency, high supply voltage, and high capacitive loading, power dissipation can exceed the package power dissipation rating. Do not exceed the maximum package power dissipation rating. See the *Absolute Maximum Ratings* for maximum package power dissipation capacity and temperature derating.

Rising- or Falling-Edge Output Strobe

The MAX9242 has a rising-edge output strobe, which latches the parallel output data into the next chip on the rising edge of RxCLKOUT. The MAX9244/MAX9246 have a falling-edge output strobe, which latches the parallel output data into the next chip on the falling edge of RxCLKOUT. The deserializer output strobe polarity does not need to match the serializer input strobe polarity.

Three-Level Logic Inputs

SSG and DCB (DCB mid level is reserved) are three-level-logic inputs. A logic-high input voltage must be greater than +2.5V and a logic-low input voltage must be less than +0.8V. A mid-level logic is recognized by the MAX9242/MAX9244/MAX9246 when the input is left open or connected to a driver in a high-impedance state. A weak inverter on the input stage of SSG and

DCB provides the proper mid-level voltage under conditions of low input current. The mid-level input current must not be greater than ±10µA, and the mid-level logic state cannot be driven with an external voltage source.

IEC 61000-4-2 Level 4 and ISO 10605 ESD Protection

The MAX9242/MAX9244/MAX9246 ESD tolerance is rated for Human Body Model, IEC 61000-4-2 and ISO 10605. The ISO 10605 and IEC 61000-4-2 standards specify ESD tolerance for electronic systems. All LVDS inputs on the MAX9242/MAX9244/MAX9246 meet ISO 10605 ESD protection at ±30kV Air-Gap Discharge and ±6kV Contact Discharge and IEC 61000-4-2 ESD protection at ±15kV Air-Gap Discharge and ±8kV Contact Discharge. All other pins meet the Human Body Model ESD tolerance of ±2.5kV. The Human Body Model discharge components are C_S = 100pF and R_D = 1.5kΩ (Figure 21). The IEC 61000-4-2 discharge components are C_S = 150pF and R_D = 330Ω (see Figure 22). The ISO 10605 discharge components are C_S = 330pF and R_D = 2kΩ (Figure 23).

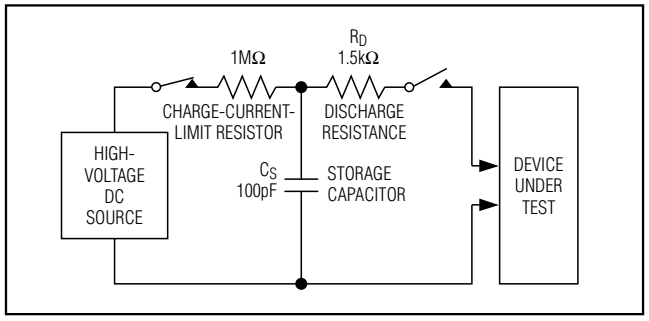


Figure 21. Human Body ESD Test Circuit

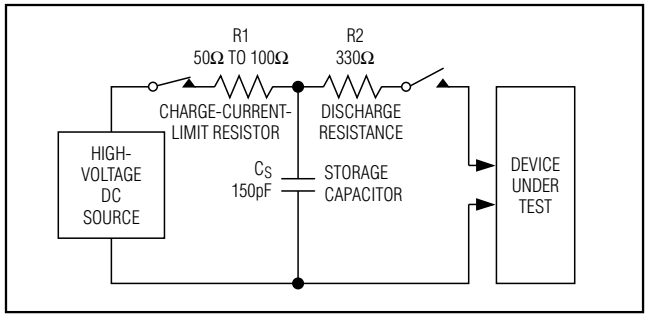


Figure 22. IEC 61000-4-2 Contact Discharge ESD Test Circuit

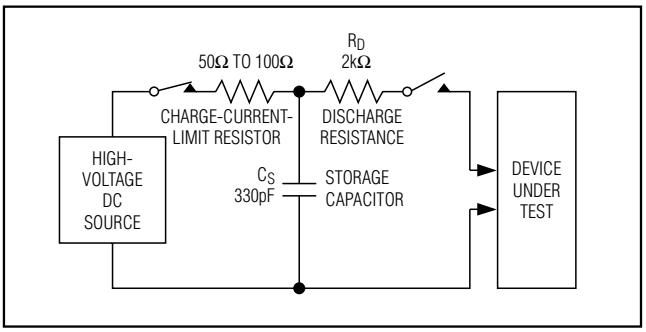
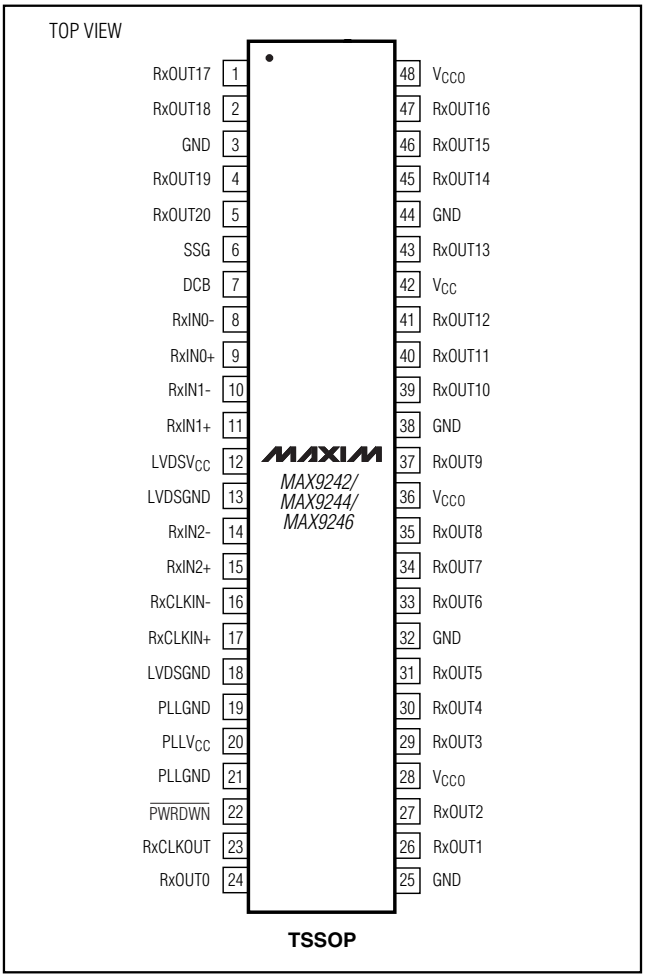


Figure 23. ISO 10605 Contact Discharge ESD Test Circuit

Pin Configuration



Chip Information

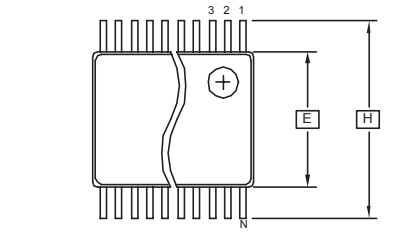
PROCESS: CMOS

21-Bit Deserializers with Programmable Spread Spectrum and DC Balance

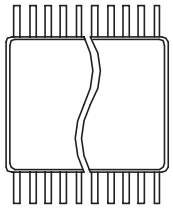
Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

48L TSSOP.EPS

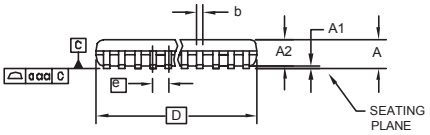


TOP VIEW

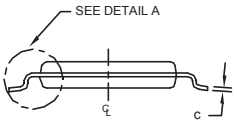


BOTTOM VIEW

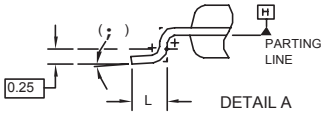
SYMBOL	COMMON DIMENSIONS		
	MIN.	NOM.	MAX.
A	--	--	1.10
A1	0.05	--	0.15
A2	0.55	0.90	0.95
aaa		0.10	
b	0.17	--	0.27
b1	0.17	0.20	0.23
c	0.09	--	0.20
c1	0.09	0.127	0.16
D	12.40	12.50	12.60
E	6.00	6.10	6.20
e		0.50 BSC	
H		8.10 BSC	
L	0.50	0.60	0.75
N		48	
;	0°	--	8°



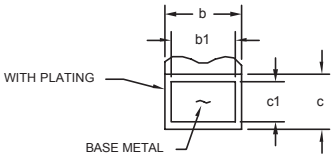
SIDE VIEW



END VIEW



DETAIL A



SECTION C-C

NOTES:

1. DIMENSIONS D & E ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15MM ON D SIDE, AND 0.25MM ON E SIDE.
3. CONTROLLING DIMENSION: MILLIMETERS.
4. THIS PART IS COMPLIANT WITH JEDEC SPECIFICATION MO-153, VARIATIONS, ED.
5. "N" REFERS TO NUMBER OF LEADS.
6. THE LEAD TIPS MUST LIE WITHIN A SPECIFIED ZONE. THIS TOLERANCE ZONE IS DEFINED BY TWO PARALLEL PLANES. ONE PLANE IS THE SEATING PLANE, DATUM (-C-), THE OTHER PLANE IS AT THE SPECIFIED DISTANCE FROM (-C-) IN THE DIRECTION INDICATED.

DALLAS SEMICONDUCTOR MAXIM

PROPRIETARY INFORMATION

TITLE: PACKAGE OUTLINE, 48L TSSOP, 6.1mm BODY

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0155	B	1/1

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